Lattice Semiconductor Corporation - LFSC3GA80E-6FF1704C Datasheet

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	20000
Number of Logic Elements/Cells	80000
Total RAM Bits	5816320
Number of I/O	904
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1704-BBGA, FCBGA
Supplier Device Package	1704-OFCBGA (42.5x42.5)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfsc3ga80e-6ff1704c

Figure 2-27. Output Termination Schemes

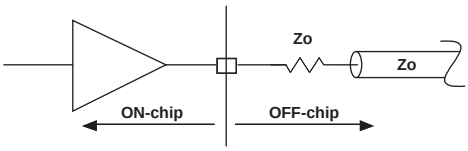
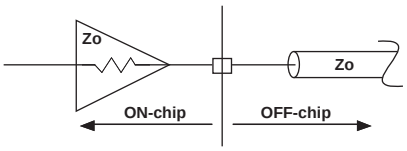
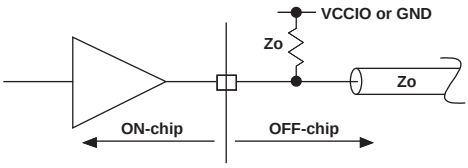
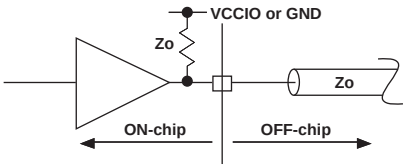
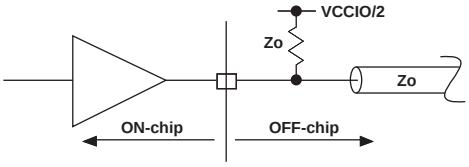
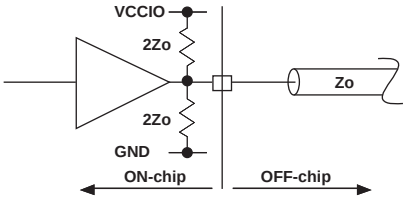
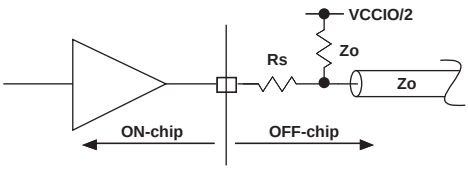
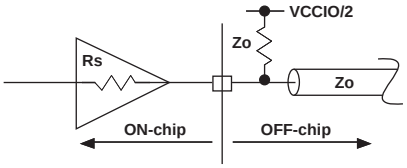
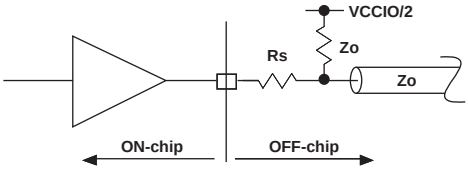
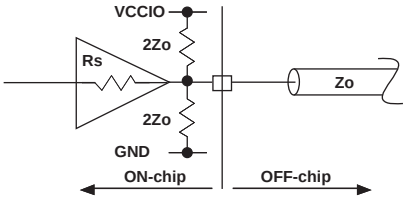
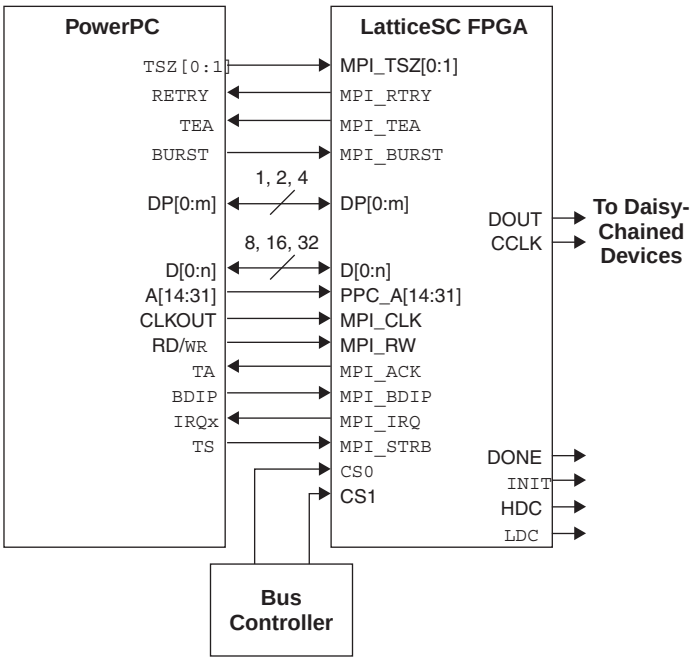
Termination Type	Discrete Off-Chip Solution	Lattice On-Chip Solution
Series termination (controlled output impedance)		
Parallel termination to V_{CCIO}, or parallel driving end		
Parallel termination to $V_{CCIO}/2$ driving end		
Combined series + parallel termination to $V_{CCIO}/2$ at driving end (only series termination moved on-chip)		
Combined series + parallel to $V_{CCIO}/2$ driving end		

Figure 2-32. PowerPCI and MPI Schematic



Configuration and Testing

The following section describes the configuration and testing features of the LatticeSC family of devices.

IEEE 1149.1-Compliant Boundary Scan Testability

All LatticeSC devices have boundary scan cells that are accessed through an IEEE 1149.1 compliant test access port (TAP). This allows functional testing of the circuit board, on which the device is mounted, through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test data to be captured and shifted out for verification. The test access port consists of dedicated I/Os: TDI, TDO, TCK and TMS. The test access port has its own supply voltage V_{CCJ} and can operate with LVCMOS33, 25 and 18 standards. For additional detail refer to technical information at the end of the data sheet.

Device Configuration

All LatticeSC devices contain three possible ports that can be used for device configuration. The serial port, which supports bit-wide configuration, and the sysCONFIG port that supports both byte-wide and serial configuration. The MPI port supports 8-bit, 16-bit or 32-bit configuration.

The serial port supports both the IEEE Std. 1149.1 Boundary Scan specification and the IEEE Std. 1532 In-System Configuration specification. The sysCONFIG port is a 20-pin interface with six of the I/Os used as dedicated pins and the rest being dual-use pins. When sysCONFIG mode is not used, these dual-use pins are available for general purpose I/O. All I/Os for the sysCONFIG and MPI ports are in I/O bank #1.

On power-up, the FPGA SRAM is ready to be configured with the sysCONFIG port active. The IEEE 1149.1 serial mode can be activated any time after power-up by sending the appropriate command through the TAP port. Once a configuration port is selected, that port is locked and another configuration port cannot be activated until the next re-initialization sequence. For additional detail refer to technical information at the end of the data sheet.

PURESPEED I/O Recommended Operating Conditions

Standard	V_{CCIO} (V)			V_{REF} (V)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
LVCMOS 33	3.135	3.3	3.465	—	—	—
LVCMOS 25	2.375	2.5	2.625	—	—	—
LVCMOS 18	1.71	1.8	1.89	—	—	—
LVCMOS 15	1.425	1.5	1.575	—	—	—
LVCMOS 12	1.14	1.2	1.26	—	—	—
LVTTL	3.135	3.3	3.465	—	—	—
PCI33	3.135	3.3	3.465	—	—	—
PCIX33	3.135	3.3	3.465	—	—	—
PCIX15	1.425	1.5	1.575	$0.49V_{CCIO}$	$0.5V_{CCIO}$	$0.51V_{CCIO}$
AGP1X33	3.135	3.3	3.465	—	—	—
AGP2X33	3.135	3.3	3.465	$0.39V_{CCIO}$	$0.4V_{CCIO}$	$0.41V_{CCIO}$
SSTL18_I, II[3]	1.71	1.8	1.89	0.833	0.9	0.969
SSTL25_I, II[3]	2.375	2.5	2.625	1.15	1.25	1.35
SSTL33_I, II[3]	3.135	3.3	3.465	1.3	1.5	1.7
HSTL15_I, II[3]	1.425	1.5	1.575	0.68	0.75	0.9
HSTL15_III[1, 3] and IV[1, 3]	1.425	1.5	1.575	0.68	0.9	0.9
HSTL 18_I[3], II[3]	1.71	1.8	1.89	0.816	0.9	1.08
HSTL 18_ III[1, 3], IV[1, 3]	1.71	1.8	1.89	0.816	1.08	1.08
GTL12[1, 3], GTLPLUS15[1, 3]	—	—	—	0.882	1.0	1.122
LVDS	—	—	—	—	—	—
Mini-LVDS	—	—	—	—	—	—
RSDS	—	—	—	—	—	—
LVPECL33 (outputs)[2]	3.135	3.3	3.465	—	—	—
LVPECL33 (inputs)[2, 4]	—	≤ 2.5	—	—	—	—
BLVDS25[2, 3]	2.375	2.5	2.625	—	—	—
MLVDS25[2, 3]	2.375	2.5	2.625	—	—	—
SSTL18D_I[3], II[3]	1.71	1.8	1.89	—	—	—
SSTL25D_I[3], II[3]	2.375	2.5	2.625	—	—	—
SSTL33D_I[3], II[3]	3.135	3.3	3.465	—	—	—
HSTL15D_I[3], II[3]	1.425	1.5	1.575	—	—	—
HSTL18D_I[3], II[3]	1.71	1.8	1.89	—	—	—

1. Input only.
2. Inputs on chip. Outputs are implemented with the addition of external resisters.
3. Input for this standard does not depend on the value of V_{CCIO}.
4. Inputs for this standard cannot be in 3.3V VCCIO banks (≤ 2.5V only).

PURESPEED I/O Differential Electrical Characteristics

LVDS

Over Recommended Operating Conditions

Parameter Symbol	Parameter Description	Test Conditions	Min.	Typ.	Max.	Units
V_{INP}, V_{INM}	Input voltage		0	—	2.4	V
V_{THD}	Differential input threshold (Q-$\overline{Q}$)		+/-100	—	—	mV
V_{CM}	Input common mode voltage		0.05	1.2	2.35	V
I_{IN}	Input current	Power on or power off	—	—	+/-10	µA
V_{OH}	Output high voltage for V_{OP} or V_{OM}	R_T = 100 Ohm	—	1.38	1.60	V
V_{OL}	Output low voltage for V_{OP} or V_{OM}	R_T = 100 Ohm	0.9V	1.03	—	V
V_{OD}	Output voltage differential	(V_{OP} - V_{OM}), R_T = 100 Ohm	250	350	450	mV
ΔV_{OD}	Change in V_{OD} between high and low		—	—	50	mV
V_{OS}	Output voltage offset	(V_{OP} - V_{OM})/2, R_T = 100 Ohm	1.125	1.20	1.375	V
ΔV_{OS}	Change in V_{OS} between H and L		—	—	50	mV
I_{SAB}	Output short circuit current	V_{OD} = 0V Driver outputs shorted	—	—	12	mA
T_R, T_F	Output rise and fall times, 20% to 80%	—	—	500	ps	T_R, T_F

Notes:
1. Data is for 3.5mA differential current drive. Other differential driver current options are available.
2. If the low power mode of the input buffer is used, the minimum V_{CM} is 600 mV.

Mini-LVDS

Over Recommended Operating Conditions

Parameter Symbol	Description	Min.	Typ.	Max.	Units
Z_O	Single-ended PCB trace impedance	30	50	75	ohms
R_T	Differential termination resistance	60	100	150	ohms
V_{OD}	Output voltage, differential, $\|V_{OP} - V_{OM}\|$	300	—	600	mV
V_{OS}	Output voltage, common mode, $\|V_{OP} + V_{OM}\|/2$	1	1.2	1.4	V
ΔV_{OD}	Change in V_{OD}, between H and L	—	—	50	mV
ΔV_{ID}	Change in V_{OS}, between H and L	—	—	50	mV
V_{THD}	Input voltage, differential, $\|V_{INP} - V_{INM}\|$	200	—	600	mV
V_{CM}	Input voltage, common mode, $\|V_{INP} + V_{INM}\|/2$	0.3+(V_{THD}/2)	—	2.1-(V_{THD}/2)	
T_R, T_F	Output rise and fall times, 20% to 80%	—	—	500	ps
T_{ODUTY}	Output clock duty cycle	45	—	55	%
T_{IDUTY}	Input clock duty cycle	40	—	60	%

Note: Data is for 6mA differential current drive. Other differential driver current options are available.

LatticeSC/M Internal Timing Parameters[1] (Continued)

Over Recommended Commercial Operating Conditions at VCC = 1.2V +/- 5%

Parameter	Symbol	Description	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
EBR Timing									
t_{CO_EBR}	CK_Q_DEL	Clock (Read) to output from Address or Data	—	1.900	—	2.116	—	2.335	ns
t_{COO_EBR}	CK_Q_DEL	Clock (Write) to output from EBR output Register	0.390	—	0.444	—	0.498	—	ns
t_{SUDATA_EBR}	D_CK_SET	Setup Data to EBR Memory (Write clk)	-0.173	—	-0.192	—	-0.210	—	ns
t_{HDATA_EBR}	D_CK_HLD	Hold Data to EBR Memory (Write clk)	0.276	—	0.305	—	0.335	—	ns
t_{SUADDR_EBR}	A_CK_SET	Setup Address to EBR Memory (Write clk)	-0.165	—	-0.182	—	-0.200	—	ns
t_{HADDR_EBR}	A_CK_HLD	Hold Address to EBR Memory (Write clk)	0.269	—	0.298	—	0.327	—	ns
t_{SUWREN_EBR}	CE_CK_SET	Setup Write/Read Enable to EBR Memory (Write/Read clk)	0.225	—	0.226	—	0.226	—	ns
t_{HWREN_EBR}	CE_CK_HLD	Hold Write/Read Enable to EBR Memory (write/read clk)	0.073	—	0.095	—	0.116	—	ns
t_{SUCE_EBR}	CS_CK_SET	Clock Enable Setup Time to EBR Output Register (Read clk)	0.261	—	0.269	—	0.276	—	ns
t_{HCE_EBR}	CS_CK_HLD	Clock Enable Hold Time to EBR Output Register (Read clk)	0.023	—	0.039	—	0.055	—	ns
t_{RSTO_EBR}	RESET_Q_DEL	Reset To Output Delay Time from EBR Output Register (asynchronous)	—	0.589	—	0.673	—	0.757	ns
Cycle Boosting Timing									
t_{DEL1}	DEL1	Cycle boosting delay 1 applies to PIO, PFU, EBR	—	0.480	—	0.524	—	0.570	ns
t_{DEL2}	DEL2	Cycle boosting delay 2 applies to PIO, PFU, EBR	—	0.922	—	1.005	—	1.090	ns
t_{DEL3}	DEL3	Cycle boosting delay 3 applies to PIO, PFU, EBR	—	1.366	—	1.488	—	1.612	ns

1. Complete timing parameters for a user design will be incorporated when running ispLEVER. This is a sampling of the key timing parameters.

Input Delay Block/AIL Timing

Parameter	Description	Min.	Typ.	Max.	Units
t_{FDEL}	Fine delay time	35	45	80	ps
t_{CDEL}	Coarse delay time	1120	1440	2560	ps
jt_{AIL}	AIL jitter tolerance	1- ((N^1 * t_{FDEL}) / (Clock Period))			UI

1. N = number of fine delays used in a particular AIL setting

GSR Timing

Parameter	Description	VCC	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
$t_{SYNC\_GSR\_MAX}$	Maximum operating frequency for synchronous GSR	1.14V	—	438	—	417	—	398	MHz
		0.95V	—	378	—	355	—	337	MHz
$t_{ASYNC\_GSR\_MPW}$	Minimum pulse width of asynchronous input	—	—	—	—	—	3.3	—	ns

Note: Synchronous GSR goes out of reset in two cycles from the clock edge where the setup time of the FF was met.

Internal System Bus Timing

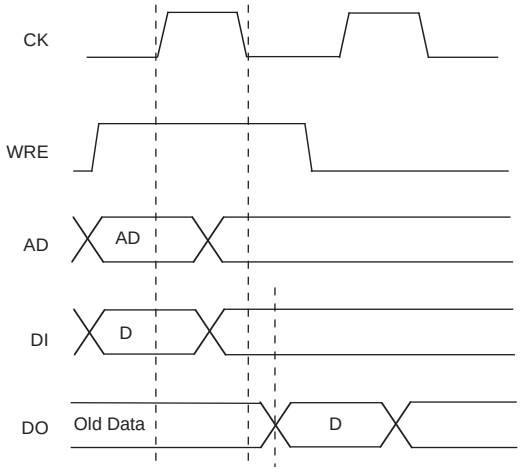
Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t_{HCLK}	Maximum operating frequency for internal system bus HCLK.	—	200	—	200	—	200	MHz

Note: There is no minimum frequency. If HCLK is sourced from the embedded oscillator, the minimum frequency limitation of the oscillator/ divider is about 0.3 MHz. Refer to the osciallator data for missing configuration modes.

Timing Diagrams

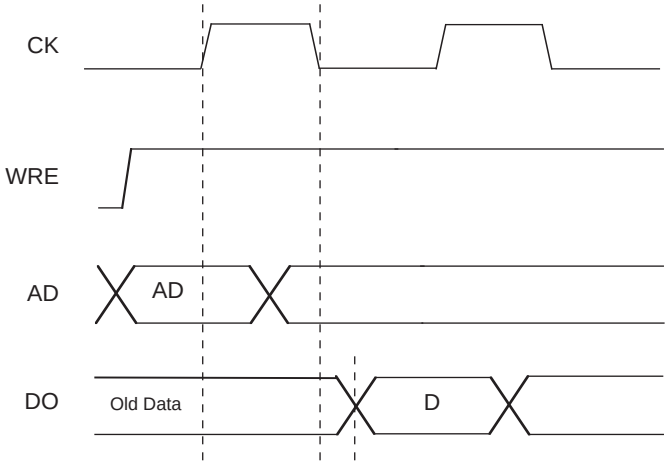
PFU Timing Diagrams

Figure 3-4. Slice Single/Dual Port Write Cycle Timing



Notes:
- Rising Edge for latching WREN, WAD and DATAIN.
- WREN must continue past falling edge clock.
- Data output occurs on negative edge.

Figure 3-5. Slice Single/Dual Port Read Cycle Timing



Signal Descriptions (Cont.)

Signal Name	I/O	Description
PROBE_GND	—	GND signal - Connected to internal VSS node. Can be used for feedback to control an external board power converter. Can be unconnected if not used.
PLL and Clock Functions (Used as user-programmable I/O pins when not in use for PLL, DLL or clock pins.)		
[LOC]_PLL[T, C]_FB_[A/B]	I	PLL feedback input. Pull-ups are enabled on input pins during configuration. [LOC] indicates the corner the PLL is located in: ULC (upper left), URC (upper right), LLC (lower left) and LRC (lower right). [T, C] indicates whether input is true or complement. [A, B] indicates PLL reference within the corner.
[LOC]_DLL[T, C]_FB_[C, D, E, F]	I	DLL feedback input. Pull-ups are enabled on input pins during configuration. [LOC] indicates the corner the DLL is located in: ULC (upper left), URC (upper right), LLC (lower left) and LRC (lower right). [T/C] indicates whether input is true or complement. [C, D, E, F] indicates DLL reference within a corner. Note: E and F are only available on the lower corners.
[LOC]_PLL[T, C]_IN[A/B]	I	PLL reference clock input. Pull-ups are enabled on input pins during configuration. [LOC] indicates the corner the PLL is located in: ULC (upper left corner), URC (upper right corner), LLC (lower left corner) and LRC (lower right corner). [T, C] indicates whether input is true or complement.[A, B] indicates PLL reference within the corner.
[LOC]_DLL[T, C]_IN[C, D, E, F]		DLL reference clock inputs. Pull-ups are enabled on input pins during configuration. [LOC] indicates the corner the DLL is located in: ULC (upper left corner), URC (upper right corner), LLC (lower left corner) and LRC (lower right corner). [T/C] indicates whether input is true or complement. [C, D, E, F] indicates DLL reference within a corner. Note: E and F are only available on the lower corners. PCKLxy_[0:3] can drive primary clocks, edge clocks, and CLKDIVs. PCLKxy_[4:7] can only drive edge clocks.
PCLKxy_z		General clock inputs. x indicates whether T (true) or C (complement). y indicates the I/O bank the clock is associated with. z indicates the clock number within a bank.
Test and Programming (Dedicated pins. Pull-up is enabled on input pins during configuration.)		
TMS	I	Test Mode Select input, used to control the 1149.1 state machine.
TCK	I	Test Clock input pin, used to clock the 1149.1 state machine.
TDI	I	Test Data in pin, used to load data into device using 1149.1 state machine. After power-up, this TAP port can be activated for configuration by sending appropriate command. (Note: once a configuration port is selected it is locked. Another configuration port cannot be selected until the power-up sequence).
TDO	O	Output pin -Test Data out pin used to shift data out of device using 1149.1.
Configuration Pads (Dedicated pins. Used during sysCONFIG.)		
M[3:0]	I	Mode pins used to specify configuration modes values latched on rising edge of INITN.
INITN	I/O	Open Drain pin - Indicates the FPGA is ready to be configured. During configuration, a pull-up is enabled that will pull the I/O above 1.5V.
PROGRAMN	I	Initiates configuration sequence when asserted low. This pin always has an active pull-up.
DONE	I/O	Open Drain pin - Indicates that the configuration sequence is complete, and the startup sequence is in progress.
CCLK	I/O	Configuration Clock for configuring an FPGA in sysCONFIG mode.

Pin Information Summary (Cont.)

Pin Type		1152 fcBGA			1704 fcBGA	
		LFSC/M40	LFSC/M80	LFSC/M115	LFSC/M80	LFSC/M115
Single Ended User I/O		604	660	660	904	942
Differential Pair User I/O		302	330	330	452	470
LVDS Output Pairs		78	102	102	114	132
Configuration	Dedicated	11	11	11	11	11
	Muxes/MPI sysBus	72	72	72	72	72
JTAG (excluding VCCJ)		4	4	4	4	4
Dedicated Pins		4	4	4	4	4
VCC		44	44	44	76	76
VCC12		52	52	52	88	88
VCCAUX		38	38	38	52	52
VCCIO	Bank 1	10	10	10	10	10
	Bank 2	9	9	9	12	12
	Bank 3	12	12	12	14	14
	Bank 4	12	12	12	14	14
	Bank 5	12	12	12	14	14
	Bank 6	12	12	12	14	14
	Bank 7	9	9	9	12	12
VTT	Bank 2	3	3	3	4	4
	Bank 3	3	3	3	4	4
	Bank 4	3	3	3	5	5
	Bank 5	3	3	3	5	5
	Bank 6	3	3	3	4	4
	Bank 7	3	3	3	4	4
GND		130	130	130	184	184
NC		62	6	6	52	14
Single Ended User / Differential I/O per Bank	Bank 1	80/40	80/40	80/40	80/40	80/40
	Bank 2	60/30	76/38	76/38	96/48	103/51
	Bank 3	96/48	108/54	108/54	132/66	144/72
	Bank 4	106/53	106/53	106/53	184/92	184/92
	Bank 5	106/53	106/53	106/53	184/92	184/92
	Bank 6	96/48	108/54	108/54	132/66	144/72
	Bank 7	60/30	76/38	76/38	96/48	103/51
LVDS Output Pairs Per Bank	Bank 2	15	21	21	24	27
	Bank 3	24	30	30	33	39
	Bank 6	24	30	30	33	39
	Bank 7	15	21	21	24	27
VCCJ		1	1	1	1	1
SERDES (signal + power supply)		108	108	108	212	212
Total		1152	1152	1152	1704	1704

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA[1, 2] (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
P22	VCCIO2	-		VCCIO2	-	
R22	VCCIO2	-		VCCIO2	-	
AA23	VCCIO3	-		VCCIO3	-	
AA24	VCCIO3	-		VCCIO3	-	
AB23	VCCIO3	-		VCCIO3	-	
AB24	VCCIO3	-		VCCIO3	-	
T22	VCCIO3	-		VCCIO3	-	
U22	VCCIO3	-		VCCIO3	-	
V22	VCCIO3	-		VCCIO3	-	
W22	VCCIO3	-		VCCIO3	-	
Y22	VCCIO3	-		VCCIO3	-	
Y23	VCCIO3	-		VCCIO3	-	
Y24	VCCIO3	-		VCCIO3	-	
AB16	VCCIO4	-		VCCIO4	-	
AB17	VCCIO4	-		VCCIO4	-	
AB18	VCCIO4	-		VCCIO4	-	
AB19	VCCIO4	-		VCCIO4	-	
AB20	VCCIO4	-		VCCIO4	-	
AC20	VCCIO4	-		VCCIO4	-	
AC21	VCCIO4	-		VCCIO4	-	
AC22	VCCIO4	-		VCCIO4	-	
AD20	VCCIO4	-		VCCIO4	-	
AD21	VCCIO4	-		VCCIO4	-	
AD22	VCCIO4	-		VCCIO4	-	
AB11	VCCIO5	-		VCCIO5	-	
AB12	VCCIO5	-		VCCIO5	-	
AB13	VCCIO5	-		VCCIO5	-	
AB14	VCCIO5	-		VCCIO5	-	
AB15	VCCIO5	-		VCCIO5	-	
AC10	VCCIO5	-		VCCIO5	-	
AC11	VCCIO5	-		VCCIO5	-	
AC9	VCCIO5	-		VCCIO5	-	
AD10	VCCIO5	-		VCCIO5	-	
AD11	VCCIO5	-		VCCIO5	-	
AD9	VCCIO5	-		VCCIO5	-	
AA7	VCCIO6	-		VCCIO6	-	
AA8	VCCIO6	-		VCCIO6	-	
AB7	VCCIO6	-		VCCIO6	-	
AB8	VCCIO6	-		VCCIO6	-	
T9	VCCIO6	-		VCCIO6	-	
U9	VCCIO6	-		VCCIO6	-	
V9	VCCIO6	-		VCCIO6	-	
W9	VCCIO6	-		VCCIO6	-	
Y7	VCCIO6	-		VCCIO6	-	
Y8	VCCIO6	-		VCCIO6	-	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
Y24	PL48C	6		PL61C	6	
Y23	PL48D	6		PL61D	6	
AD29	PL49A	6		PL62A	6	
AD30	PL49B	6		PL62B	6	
AF28	PL49C	6		PL62C	6	
AE28	PL49D	6		PL62D	6	
AC28	PL51A	6		PL65A	6	
AD28	PL51B	6		PL65B	6	
AB26	PL51C	6		PL65C	6	
AC26	PL51D	6	VREF2_6	PL65D	6	VREF2_6
AC32	PL52A	6		PL66A	6	
AD32	PL52B	6		PL66B	6	
AA24	PL52C	6		PL66C	6	
AA23	PL52D	6		PL66D	6	
AE30	PL53A	6		PL67A	6	
AE29	PL53B	6		PL67B	6	
AC25	PL53C	6		PL67C	6	
AB25	PL53D	6		PL67D	6	
AE31	PL55A	6		PL69A	6	
AE32	PL55B	6		PL69B	6	
AE26	PL55C	6	LLC_DLLT_IN_E/LLC_DLLT_FB_F	PL69C	6	LLC_DLLT_IN_E/LLC_DLLT_FB_F
AE27	PL55D	6	LLC_DLLC_IN_E/LLC_DLLC_FB_F	PL69D	6	LLC_DLLC_IN_E/LLC_DLLC_FB_F
AF32	PL56A	6		PL70A	6	
AF31	PL56B	6		PL70B	6	
AC24	PL56C	6		PL70C	6	
AD25	PL56D	6		PL70D	6	
AG32	PL57A	6	LLC_DLLT_IN_F/LLC_DLLT_FB_E	PL71A	6	LLC_DLLT_IN_F/LLC_DLLT_FB_E
AG31	PL57B	6	LLC_DLLC_IN_F/LLC_DLLC_FB_E	PL71B	6	LLC_DLLC_IN_F/LLC_DLLC_FB_E
AC23	PL57C	6	LLC_PLLT_IN_B/LLC_PLLT_FB_A	PL71C	6	LLC_PLLT_IN_B/LLC_PLLT_FB_A
AD24	PL57D	6	LLC_PLLC_IN_B/LLC_PLLC_FB_A	PL71D	6	LLC_PLLC_IN_B/LLC_PLLC_FB_A
AH32	XRES	-		XRES	-	
AH31	TEMP	6		TEMP	6	
AJ32	PB3A	5	LLC_PLLT_IN_A/LLC_PLLT_FB_B	PB3A	5	LLC_PLLT_IN_A/LLC_PLLT_FB_B
AK32	PB3B	5	LLC_PLLC_IN_A/LLC_PLLC_FB_B	PB3B	5	LLC_PLLC_IN_A/LLC_PLLC_FB_B
AF27	PB3C	5	LLC_DLLT_IN_C/LLC_DLLT_FB_D	PB3C	5	LLC_DLLT_IN_C/LLC_DLLT_FB_D
AG28	PB3D	5	LLC_DLLC_IN_C/LLC_DLLC_FB_D	PB3D	5	LLC_DLLC_IN_C/LLC_DLLC_FB_D
AK31	PB4A	5	LLC_DLLT_IN_D/LLC_DLLT_FB_C	PB4A	5	LLC_DLLT_IN_D/LLC_DLLT_FB_C
AL31	PB4B	5	LLC_DLLC_IN_D/LLC_DLLC_FB_C	PB4B	5	LLC_DLLC_IN_D/LLC_DLLC_FB_C
AE25	PB4C	5		PB4C	5	
AE24	PB4D	5		PB4D	5	
AK30	PB5A	5		PB5A	5	
AL30	PB5B	5		PB5B	5	
AD23	PB5C	5		PB5C	5	
AE23	PB5D	5	VREF1_5	PB5D	5	VREF1_5
AK29	PB7A	5		PB7A	5	
AL29	PB7B	5		PB7B	5	
AF26	PB7C	5		PB7C	5	
AF25	PB7D	5		PB7D	5	
AJ28	PB8A	5		PB8A	5	
AK28	PB8B	5		PB8B	5	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
B1	GND	-		GND	-	
B32	GND	-		GND	-	
C11	GND	-		GND	-	
C12	GND	-		GND	-	
C16	GND	-		GND	-	
C21	GND	-		GND	-	
C22	GND	-		GND	-	
C24	GND	-		GND	-	
C25	GND	-		GND	-	
C26	GND	-		GND	-	
C27	GND	-		GND	-	
C29	GND	-		GND	-	
C3	GND	-		GND	-	
C30	GND	-		GND	-	
C4	GND	-		GND	-	
C6	GND	-		GND	-	
C7	GND	-		GND	-	
C8	GND	-		GND	-	
C9	GND	-		GND	-	
D17	GND	-		GND	-	
F18	GND	-		GND	-	
F3	GND	-		GND	-	
F30	GND	-		GND	-	
F9	GND	-		GND	-	
G15	GND	-		GND	-	
G24	GND	-		GND	-	
G29	GND	-		GND	-	
G3	GND	-		GND	-	
J14	GND	-		GND	-	
J22	GND	-		GND	-	
J26	GND	-		GND	-	
J6	GND	-		GND	-	
K11	GND	-		GND	-	
K19	GND	-		GND	-	
K30	GND	-		GND	-	
K4	GND	-		GND	-	
L23	GND	-		GND	-	
L9	GND	-		GND	-	
M13	GND	-		GND	-	
M15	GND	-		GND	-	
M18	GND	-		GND	-	
M20	GND	-		GND	-	
M27	GND	-		GND	-	
M7	GND	-		GND	-	
N12	GND	-		GND	-	
N14	GND	-		GND	-	
N19	GND	-		GND	-	
N21	GND	-		GND	-	
N29	GND	-		GND	-	
N3	GND	-		GND	-	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
C32	VCC12	-		VCC12	-	
E34	NC	-		PL22A	7	
F34	NC	-		PL22B	7	
F33	NC	-		PL24A	7	
G33	NC	-		PL24B	7	
K30	NC	-		PL25A	7	
L30	NC	-		PL25B	7	
G34	NC	-		PL26A	7	
H34	NC	-		PL26B	7	
M32	NC	-		PL39A	7	
N32	NC	-		PL39B	7	
P28	NC	-		PL39C	7	
R28	NC	-		PL39D	7	
J34	NC	-		PL41A	7	
K34	NC	-		PL41B	7	
P30	NC	-		PL41C	7	
R30	NC	-		PL41D	7	
W34	NC	-		PL59A	6	
Y34	NC	-		PL59B	6	
W32	NC	-		PL61A	6	
Y32	NC	-		PL61B	6	
AA34	NC	-		PL64A	6	
AB34	NC	-		PL64B	6	
AC34	NC	-		PL67A	6	
AD34	NC	-		PL67B	6	
Y30	NC	-		PL68A	6	
AA30	NC	-		PL68B	6	
AB33	NC	-		PL69A	6	
AC33	NC	-		PL69B	6	
AC2	NC	-		PR69B	3	
AB2	NC	-		PR69A	3	
AA5	NC	-		PR68B	3	
Y5	NC	-		PR68A	3	
AD1	NC	-		PR67B	3	
AC1	NC	-		PR67A	3	
AB1	NC	-		PR64B	3	
AA1	NC	-		PR64A	3	
Y3	NC	-		PR61B	3	
W3	NC	-		PR61A	3	
Y1	NC	-		PR59B	3	
W1	NC	-		PR59A	3	
R5	NC	-		PR41D	2	
P5	NC	-		PR41C	2	
K1	NC	-		PR41B	2	
J1	NC	-		PR41A	2	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AC19	VTT_5	5		VTT_5	5	
AC20	VTT_5	5		VTT_5	5	
AD22	VTT_5	5		VTT_5	5	
AB24	VTT_6	6		VTT_6	6	
W23	VTT_6	6		VTT_6	6	
Y23	VTT_6	6		VTT_6	6	
N24	VTT_7	7		VTT_7	7	
R23	VTT_7	7		VTT_7	7	
T23	VTT_7	7		VTT_7	7	
M12	VDDAX25_R	-		VDDAX25_R	-	
M23	VDDAX25_L	-		VDDAX25_L	-	
Y16	GND	-		GND	-	
Y14	GND	-		GND	-	
N21	VCC12	-		VCC12	-	
P22	VCC12	-		VCC12	-	
AA22	VCC12	-		VCC12	-	
AB21	VCC12	-		VCC12	-	
AB14	VCC12	-		VCC12	-	
AA13	VCC12	-		VCC12	-	
P13	VCC12	-		VCC12	-	
N14	VCC12	-		VCC12	-	
G26	NC	-		NC	-	
G9	NC	-		NC	-	
J12	NC	-		NC	-	
H12	NC	-		NC	-	
H23	NC	-		NC	-	
J23	NC	-		NC	-	

1. Differential pair grouping within a PCI is A (True) and B (complement) and C (True) and D (Complement).
2. The LatticeSC/M40 and LatticeSC/M80 in an 1152-pin package support a 32-bit MPI interface.

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AL4	PR117B	3	LRC_DLLC_IN_F/LRC_DLLC_FB_E
AL3	PR117A	3	LRC_DLLT_IN_F/LRC_DLLT_FB_E
AD10	PR116D	3	
AD9	PR116C	3	
AH4	PR116B	3	
AJ4	PR116A	3	
AK5	PR115D	3	LRC_DLLC_IN_E/LRC_DLLC_FB_F
AJ5	PR115C	3	LRC_DLLT_IN_E/LRC_DLLT_FB_F
AM1	PR115B	3	
AL1	PR115A	3	
AH5	PR112D	3	
AG5	PR112C	3	
AL2	PR112B	3	
AK2	PR112A	3	
AB9	PR109D	3	
AC9	PR109C	3	
AH1	PR109B	3	
AG1	PR109A	3	
AE8	PR107D	3	VREF2_3
AD8	PR107C	3	
AJ3	PR107B	3	
AH3	PR107A	3	
AD7	PR104D	3	
AC7	PR104C	3	
AJ2	PR104B	3	
AH2	PR104A	3	
AF6	PR103D	3	
AF5	PR103C	3	
AF4	PR103B	3	
AE4	PR103A	3	
AD6	PR99D	3	
AC6	PR99C	3	
AG2	PR99B	3	
AF2	PR99A	3	
AC8	PR98D	3	
AB8	PR98C	3	
AK1	PR98B	3	
AJ1	PR98A	3	
AB10	PR96D	3	
AA10	PR96C	3	
AF3	PR96B	3	
AE3	PR96A	3	
AE5	PR94D	3	

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
J3	PR45A	2	
M8	PR43D	2	DIFFR_2
L8	PR43C	2	VREF1_2
K4	PR43B	2	
J4	PR43A	2	
M7	PR26D	2	
L7	PR26C	2	
J5	PR26B	2	
H5	PR26A	2	
N9	PR19D	2	
P9	PR19C	2	
G3	PR19B	2	
F3	PR19A	2	
J6	PR18D	2	VREF2_2
H6	PR18C	2	
E2	PR18B	2	URC_DLLC_IN_D/URC_DLLC_FB_C
D2	PR18A	2	URC_DLLT_IN_D/URC_DLLT_FB_C
P10	PR17D	2	URC_PLLC_IN_B/URC_PLLC_FB_A
N10	PR17C	2	URC_PLLT_IN_B/URC_PLLT_FB_A
G4	PR17B	2	URC_DLLC_IN_C/URC_DLLC_FB_D
F4	PR17A	2	URC_DLLT_IN_C/URC_DLLT_FB_D
J7	PR15D	2	
H7	PR15C	2	
G5	PR15B	2	URC_PLLC_IN_A/URC_PLLC_FB_B
F5	PR15A	2	URC_PLLT_IN_A/URC_PLLT_FB_B
C2	VCCJ	-	
M9	TDO	-	TDO
L9	TMS	-	
D1	TCK	-	
C1	TDI	-	
J8	PROGRAMN	1	
K8	MPIIRQN	1	CFGIRQN/MPI_IRQ_N
B2	CCLK	1	
H9	RESP_URC	-	
H10	VCC12	-	
H8	A_REFCLKN_R	-	
G8	A_REFCLKP_R	-	
C3	VCC12	-	
D3	A_VDDIB0_R	-	
A3	A_HDINP0_R	-	PCS 3E0 CH 0 IN P
B3	A_HDINN0_R	-	PCS 3E0 CH 0 IN N
E5	VCC12	-	
A4	A_HDOUTP0_R	-	PCS 3E0 CH 0 OUT P

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
H34	PL40B	7	
M32	PL53A	7	
N32	PL53B	7	
P28	PL53C	7	
R28	PL53D	7	
J34	PL55A	7	
K34	PL55B	7	
P30	PL55C	7	
R30	PL55D	7	
W34	PL73A	6	
Y34	PL73B	6	
W32	PL75A	6	
Y32	PL75B	6	
AA34	PL78A	6	
AB34	PL78B	6	
AC34	PL81A	6	
AD34	PL81B	6	
Y30	PL82A	6	
AA30	PL82B	6	
AB33	PL83A	6	
AC33	PL83B	6	
AC2	PR83B	3	
AB2	PR83A	3	
AA5	PR82B	3	
Y5	PR82A	3	
AD1	PR81B	3	
AC1	PR81A	3	
AB1	PR78B	3	
AA1	PR78A	3	
Y3	PR75B	3	
W3	PR75A	3	
Y1	PR73B	3	
W1	PR73A	3	
R5	PR55D	2	
P5	PR55C	2	
K1	PR55B	2	
J1	PR55A	2	
R7	PR53D	2	
P7	PR53C	2	
N3	PR53B	2	
M3	PR53A	2	
H1	PR40B	2	
G1	PR40A	2	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
W33	PL42C	7		PL56C	7	
Y33	PL42D	7		PL56D	7	
W37	PL43A	7		PL57A	7	
Y37	PL43B	7		PL57B	7	
Y32	PL43C	7		PL57C	7	
AA32	PL43D	7		PL57D	7	
U38	PL46A	7		PL60A	7	
V38	PL46B	7		PL60B	7	
W34	PL46C	7		PL60C	7	
Y34	PL46D	7		PL60D	7	
T40	PL47A	7	PCLKT7_1	PL61A	7	PCLKT7_1
U40	PL47B	7	PCLKC7_1	PL61B	7	PCLKC7_1
AA33	PL47C	7	PCLKT7_3	PL61C	7	PCLKT7_3
AB33	PL47D	7	PCLKC7_3	PL61D	7	PCLKC7_3
R42	PL48A	7	PCLKT7_0	PL62A	7	PCLKT7_0
T42	PL48B	7	PCLKC7_0	PL62B	7	PCLKC7_0
AA34	PL48C	7	PCLKT7_2	PL62C	7	PCLKT7_2
AB34	PL48D	7	PCLKC7_2	PL62D	7	PCLKC7_2
U41	PL50A	6	PCLKT6_0	PL64A	6	PCLKT6_0
V41	PL50B	6	PCLKC6_0	PL64B	6	PCLKC6_0
V36	PL50C	6	PCLKT6_1	PL64C	6	PCLKT6_1
W36	PL50D	6	PCLKC6_1	PL64D	6	PCLKC6_1
U42	PL51A	6		PL65A	6	
V42	PL51B	6		PL65B	6	
AB31	PL51C	6	PCLKT6_3	PL65C	6	PCLKT6_3
AC31	PL51D	6	PCLKC6_3	PL65D	6	PCLKC6_3
W38	PL52A	6		PL66A	6	
Y38	PL52B	6		PL66B	6	
AA35	PL52C	6	PCLKT6_2	PL66C	6	PCLKT6_2
AB35	PL52D	6	PCLKC6_2	PL66D	6	PCLKC6_2
W39	PL55A	6		PL69A	6	
Y39	PL55B	6		PL69B	6	
AB32	PL55C	6	VREF1_6	PL69C	6	VREF1_6
AC32	PL55D	6		PL69D	6	
W40	PL56A	6		PL70A	6	
Y40	PL56B	6		PL70B	6	
AA36	PL56C	6		PL70C	6	
AB36	PL56D	6		PL70D	6	
W41	PL57A	6		PL71A	6	
Y41	PL57B	6		PL71B	6	
AA37	PL57C	6		PL71C	6	
AB37	PL57D	6		PL71D	6	
W42	PL59A	6		PL73A	6	
Y42	PL59B	6		PL73B	6	
AC33	PL59C	6		PL73C	6	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
F5	VCC12	-		VCC12	-	
B14	C_HDOUTP3_R	-	PCS 3E2 CH 3 OUT P	C_HDOUTP3_R	-	PCS 3E2 CH 3 OUT P
E13	C_HDINN3_R	-	PCS 3E2 CH 3 IN N	C_HDINN3_R	-	PCS 3E2 CH 3 IN N
D13	C_HDINP3_R	-	PCS 3E2 CH 3 IN P	C_HDINP3_R	-	PCS 3E2 CH 3 IN P
F12	VCC12	-		VCC12	-	
G14	C_VDDIB3_R	-		C_VDDIB3_R	-	
F11	VCC12	-		VCC12	-	
K15	C_REFCLKN_R	-		C_REFCLKN_R	-	
J15	C_REFCLKP_R	-		C_REFCLKP_R	-	
G15	VCC12	-		VCC12	-	
H16	D_VDDIB0_R	-		D_VDDIB0_R	-	
D14	D_HDINP0_R	-	PCS 3E3 CH 0 IN P	D_HDINP0_R	-	PCS 3E3 CH 0 IN P
E14	D_HDINN0_R	-	PCS 3E3 CH 0 IN N	D_HDINN0_R	-	PCS 3E3 CH 0 IN N
F6	VCC12	-		VCC12	-	
B15	D_HDOUTP0_R	-	PCS 3E3 CH 0 OUT P	D_HDOUTP0_R	-	PCS 3E3 CH 0 OUT P
M13	D_VDDOB0_R	-		D_VDDOB0_R	-	
A15	D_HDOUTN0_R	-	PCS 3E3 CH 0 OUT N	D_HDOUTN0_R	-	PCS 3E3 CH 0 OUT N
F8	D_VDDOB1_R	-		D_VDDOB1_R	-	
A16	D_HDOUTN1_R	-	PCS 3E3 CH 1 OUT N	D_HDOUTN1_R	-	PCS 3E3 CH 1 OUT N
F7	VCC12	-		VCC12	-	
B16	D_HDOUTP1_R	-	PCS 3E3 CH 1 OUT P	D_HDOUTP1_R	-	PCS 3E3 CH 1 OUT P
F15	D_HDINN1_R	-	PCS 3E3 CH 1 IN N	D_HDINN1_R	-	PCS 3E3 CH 1 IN N
E15	D_HDINP1_R	-	PCS 3E3 CH 1 IN P	D_HDINP1_R	-	PCS 3E3 CH 1 IN P
K17	VCC12	-		VCC12	-	
F13	D_VDDIB1_R	-		D_VDDIB1_R	-	
C14	VCC12	-		VCC12	-	
C15	D_VDDIB2_R	-		D_VDDIB2_R	-	
D16	D_HDINP2_R	-	PCS 3E3 CH 2 IN P	D_HDINP2_R	-	PCS 3E3 CH 2 IN P
E16	D_HDINN2_R	-	PCS 3E3 CH 2 IN N	D_HDINN2_R	-	PCS 3E3 CH 2 IN N
C11	VCC12	-		VCC12	-	
B17	D_HDOUTP2_R	-	PCS 3E3 CH 2 OUT P	D_HDOUTP2_R	-	PCS 3E3 CH 2 OUT P
C9	D_VDDOB2_R	-		D_VDDOB2_R	-	
A17	D_HDOUTN2_R	-	PCS 3E3 CH 2 OUT N	D_HDOUTN2_R	-	PCS 3E3 CH 2 OUT N
D17	D_VDDOB3_R	-		D_VDDOB3_R	-	
A18	D_HDOUTN3_R	-	PCS 3E3 CH 3 OUT N	D_HDOUTN3_R	-	PCS 3E3 CH 3 OUT N
C17	VCC12	-		VCC12	-	
B18	D_HDOUTP3_R	-	PCS 3E3 CH 3 OUT P	D_HDOUTP3_R	-	PCS 3E3 CH 3 OUT P
F17	D_HDINN3_R	-	PCS 3E3 CH 3 IN N	D_HDINN3_R	-	PCS 3E3 CH 3 IN N
E17	D_HDINP3_R	-	PCS 3E3 CH 3 IN P	D_HDINP3_R	-	PCS 3E3 CH 3 IN P
F14	VCC12	-		VCC12	-	
F16	D_VDDIB3_R	-		D_VDDIB3_R	-	
G16	VCC12	-		VCC12	-	
M17	D_REFCLKN_R	-		D_REFCLKN_R	-	
L17	D_REFCLKP_R	-		D_REFCLKP_R	-	
G18	PT77D	1	HDC/SI	PT93D	1	HDC/SI

Industrial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA115E-6FC1152I[1]	-6	Ceramic fcBGA	1152	IND	115.2
LFSC3GA115E-5FC1152I[1]	-5	Ceramic fcBGA	1152	IND	115.2
LFSC3GA115E-6FF1152I	-6	Organic fcBGA	1152	IND	115.2
LFSC3GA115E-5FF1152I	-5	Organic fcBGA	1152	IND	115.2
LFSC3GA115E-6FC1704I[1]	-6	Ceramic fcBGA	1704	IND	115.2
LFSC3GA115E-5FC1704I[1]	-5	Ceramic fcBGA	1704	IND	115.2
LFSC3GA115E-6FF1704I	-6	Organic fcBGA	1704	IND	115.2
LFSC3GA115E-5FF1704I	-5	Organic fcBGA	1704	IND	115.2

1. Converted to organic flip-chip BGA package per PCN #01A-10.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA115EP1-6FC1152I[1]	-6	Ceramic fcBGA	1152	IND	115.2
LFSCM3GA115EP1-5FC1152I[1]	-5	Ceramic fcBGA	1152	IND	115.2
LFSCM3GA115EP1-6FF1152I	-6	Organic fcBGA	1152	IND	115.2
LFSCM3GA115EP1-5FF1152I	-5	Organic fcBGA	1152	IND	115.2
LFSCM3GA115EP1-6FC1704I[1]	-6	Ceramic fcBGA	1704	IND	115.2
LFSCM3GA115EP1-5FC1704I[1]	-5	Ceramic fcBGA	1704	IND	115.2
LFSCM3GA115EP1-6FF1704I	-6	Organic fcBGA	1704	IND	115.2
LFSCM3GA115EP1-5FF1704I	-5	Organic fcBGA	1704	IND	115.2

1. Converted to organic flip-chip BGA package per PCN #01A-10.